

UTC UNISONIC TECHNOLOGIES CO., LTD

5N60Z

Preliminary

5A, 600V N-CHANNEL **POWER MOSFET**

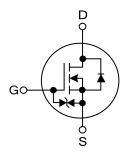
DE SCRIPTION

The U TC 5N60Z is a high voltag e po wer MOSF ET and is designed to h ave b etter cha racteristics, such as fast s witching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at hig h spee d s witching ap plications in po wer s upplies, PWM motor controls, hig h efficient DC to DC convert ers and bridge circuits.

FEAT URES

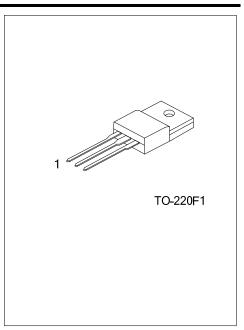
- * $R_{DS(ON)}$ = 2.2 Ω @V_{GS} = 10 V
- * Ultra Low Gate Charge (Typical 15 nC)
- * Low Reverse Transfer Capacitance (C_{RSS} = Typical 6.5 pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

SYMBOL



ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Decking	
Lead Free	Lead Free Halogen Free		1	2	3	Packing	
5N60ZL-TF1-T	5N60ZG-TF1-T	TO-220F1	G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source							
5N60ZL-TF1-T (1)Packing Type (2)Package Type		 (1) T: Tube, R: Tape Reel (2) TF1: TO-220F1 (3) L: Lead Free, G: Halogen Free 					



ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

PARAMETER SYMBOL			RATINGS	UNIT
Drain-Source Voltage		V _{DSS} 600		V
Gate-Source Voltage		V _{GSS} ±20		V
Avalanche Current (Note 2)		I _{AR} 5		А
Continuous Drain Current		I _D 5		А
Pulsed Drain Current (Note 2)		I _{DM} 20		А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS} 210		ing (
	Repetitive (Note 2)	E _{AR} 10		mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		P _D 36		W
Junction Temperature		T _J +	150	°C
Operation Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by $T_{J(\text{MAX})}$

3. L = 16.8mH, I_{AS} = 5A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

4. $I_{SD} \le 5A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ _{JC}	3.47	°C/W	



■ ELECTRICAL CHARACTERISTICS (T_c = 25°C, unless otherwise specified)

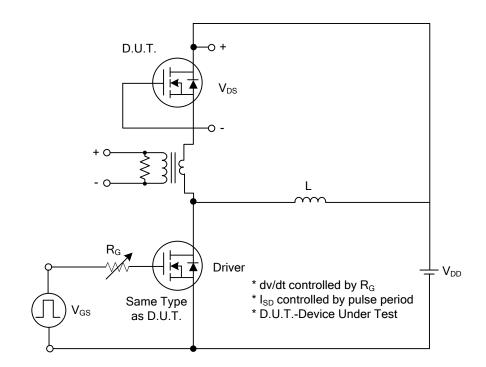
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D = 250µA 600				V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} = 0V			1	μA
Cata Cauraa Laakana Currant	Forward	V I _{GSS}	V _{GS} =20V, V _{DS} = 0V			+5	
Gate-Source Leakage Current	Reverse V		_{GS} =-20V, V _{DS} = 0V			-5	μA
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	I _D =250µA, Referenced to 25°C		0.6		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D = 250µA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D = 2.5A		1.8	2.2	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	Input Capacitance		──V _{DS} = 25V, V _{GS} = 0V, ──f = 1.0MHz		5	670	рF
Output Capacitance Reverse Transfer Capacitance		C _{ISS} C _{OSS}			55	72	рF
		C _{RSS}			6.5	8.5	pF
SWITCHING CHARACTERISTIC	S						
Turn-On Delay Time		t _{D(ON)}				30	ns
Turn-On Rise Time		t _R	V _{DD} = 300V, I _D =5A,		42	90	ns
Turn-Off Delay Time		t _{D(OFF)}	R _G = 25Ω (Note 1, 2)		38	85	ns
Turn-Off Fall Time		t _F			46	100	ns
Total Gate Charge		Q _G	V _{DS} = 480 V, I _D = 5A,	15		19	nC
Gate-Source Charge		$()_{cc}$	$V_{DS} = 400 \text{ V}, I_D = 5\text{A},$ $V_{GS} = 10 \text{ V} (Note 1, 2)$		2.5	nC	
Gate-Drain Charge		Q_{GD}	$v_{GS} = 10 v (100le 1, 2)$		6.6 nC		
DRAIN-SOURCE DIODE CHARA	CTERISTIC	S AND MAXI	MUM RATINGS				
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} = 0 V, I _S = 5A			1.4	V
Maximum Continuous Drain-Source Diode		Is				5	^
Forward Current						Э	A
Maximum Pulsed Drain-Source Diode		I _{SM}				20	А
Forward Current						20	А
Reverse Recovery Time		t _{rr}	$V_{GS} = 0 V, I_S = 5A,$		0		ns
Reverse Recovery Charge		Q _{RR}	d _{IF} / dt = 100 A/µs (Note 1) 2.2				μC
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Note 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%

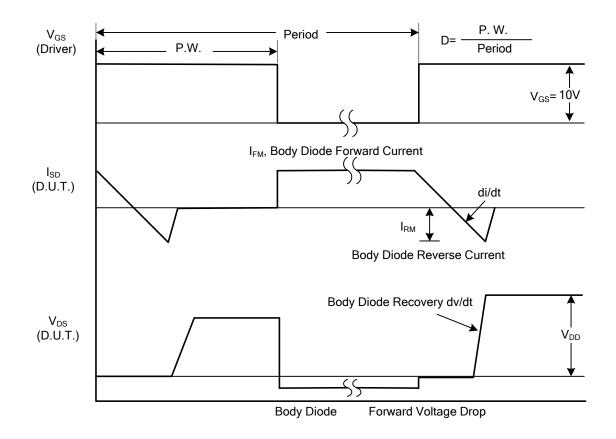
2. Essentially independent of operating temperature



TEST CIRCUITS AND WAVEFORMS



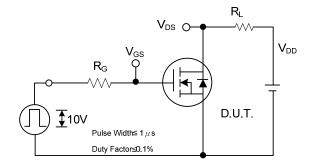
Peak Diode Recovery dv/dt Test Circuit



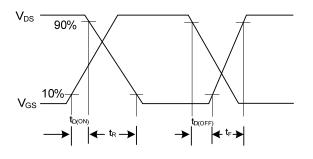
Peak Diode Recovery dv/dt Waveforms



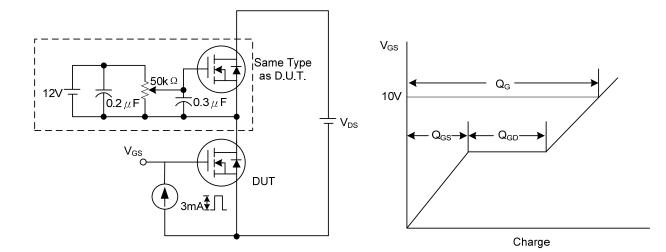
■ TEST CIRCUITS AND WAVEFORMS (Cont.)





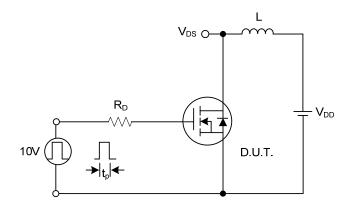


Switching Waveforms

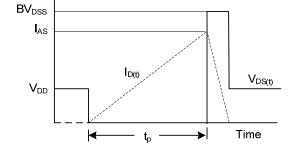


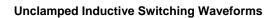
Gate Charge Test Circuit

Gate Charge Waveform











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